

NOT RECOMMENDED FOR NEW DESIGN NO ALTERNATE PRODUCT



DMG4812SSS

N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE

Product Summary

V _{(BR)DSS}	R _{DS(on)}	I _D max T _A = +25°C
30V	15mΩ @ V _{GS} = 10V	10.7A
30V	18.5mΩ @ V _{GS} = 4.5V	9.6A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(on)}$) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions

Features

- DIOFET Utilizes a Unique Patented Process to Monolithically Integrate a MOSFET and a Schottky in a Single Die to Deliver:
 - Low R_{DS(ON)}—Minimizes Conduction Losses
 - Low V_{SD}—Reduces Losses due to Body Diode Conduction
 - Low Q_{rr}—Lower Q_{rr} of the Integrated Schottky Reduces Body Diode Switching Losses
 - Low Gate Capacitance (Q_g/Q_{gs}) Ratio—Reduces Risk of SHOOT-THROUGH or Cross Conduction Currents at High Frequencies
 - Avalanche Rugged—I_{AR} and E_{AR} Rated
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.

 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.072 grams (approximate)







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S D D

Top View

Internal Schematic

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Equivalent Circuit

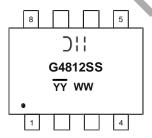
Ordering Information (Note 4)

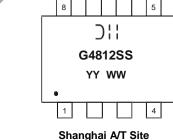
Part Number	Case	Packaging
DMG4812SSS-13	SO-8	2500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





☐ Samulacturer's Marking
☐ Handle Samulacturer's Handle Samulacturer'

YY = Date Code Marking for SAT (Shanghai Assembly/ Test site)
YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)

Chengdu A/T Site



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Character	Symbol	Value 30	Unit V		
Drain-Source Voltage Gate-Source Voltage				V_{DSS}	
			V _{GSS}	±12	V
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	$T_A = +25$ °C $T_A = +85$ °C	I _D	8 6.4	Α
Continuous Drain Current (Note 6) V _{GS} = 10V	t ≤ 10 sec	$T_A = +25$ °C $T_A = +85$ °C	I _D	10.7 8.6	Α
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t ≤ 10 sec	T _A = +25°C T _A = +85°C	I _D	9.6 7.7	А
Pulsed Drain Current (Note 7)			I _{DM}	45	Α
Avalanche Current (Notes 7 & 8)			I _{AR}	13	Α
Repetitive Avalanche Energy (Notes 7 & 8) L = 0.3mH			E _{AR}	25.4	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.54	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	R _{0JA}	81	°C/W
Power Dissipation (Note 6)	P _D	2.8	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 6)	Reja	45	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	°C

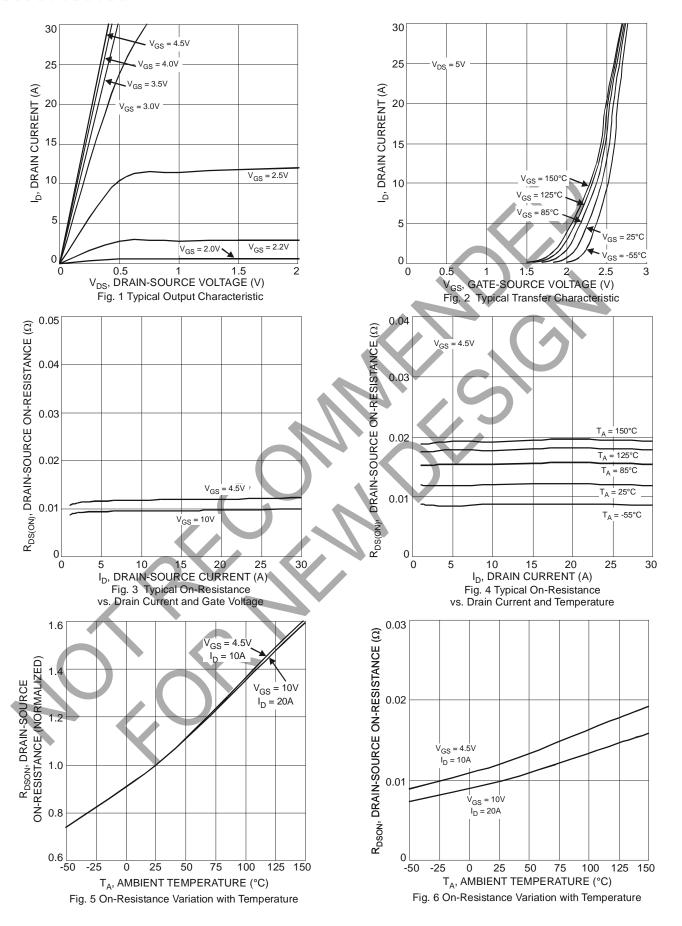
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)	Symbol	IVIIII	тур	IVIAX	Ollit	Test Condition
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V$, $I_D = 1mA$
Zero Gate Voltage Drain Current	I _{DSS}	1-	_	150	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	-1	_	±100	nA	$V_{GS} = \pm 12V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)	000					7 50
Gate Threshold Voltage	V _{GS(th)}	1.0	_	2.3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		_	11	15	mΩ	V _{GS} = 10V, I _D = 10.7A
Static Drain-Source On-Resistance	RDS (ON)	_	16.5	18.5	11177	V _{GS} = 4.5V, I _D = 9.6A
Forward Transfer Admittance	Y _{fs}	_	20	_	S	$V_{DS} = 5V, I_{D} = 10.7A$
Diode Forward Voltage	V _{SD}	_	0.36	0.5	V	$V_{GS} = 0V, I_{S} = 1A$
Maximum Body-Diode + Schottky Continuous Current	Is	_	_	5	Α	-
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	C _{iss}	_	1849	_	pF	151/1/ 01/
Output Capacitance	Coss	_	158	_	pF	V _{DS} =15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	123	_	pF	1 = 1.0MH2
Gate Resistance	R_{g}	0.54	2.0	4.0	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge V _{GS} = 4.5V	Q_g	_	18.5	_	nC	
Total Gate Charge V _{GS} = 10V	Q_g	_	43	_	nC	$V_{DS} = 15V, V_{GS} = 10V,$
Gate-Source Charge	Q _{gs}	_	4.7	_	nC	$I_D = 9.6A$
Gate-Drain Charge	Q_{gd}	_	4.0	_	nC	
Turn-On Delay Time	t _{D(on)}		6.62	_	ns	
Turn-On Rise Time	t _r		8.73	_	ns	$V_{GS} = 10V, V_{DS} = 15V,$
Turn-Off Delay Time	t _{D(off)}	_	36.41	_	ns	$R_G = 3\Omega$, $R_L = 15\Omega$, $I_D = 1A$
Turn-Off Fall Time	t _f	_	4.69	_	ns	

Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout. The value in any given application depends on the user's specific board design. 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 1 oz. Copper, single sided, device is measured at t ≤ 10 sec.
- 7. Repetitive rating, pulse width limited by junction temperature.
- 8. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = +25°C 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to production testing.







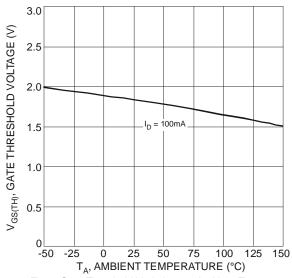
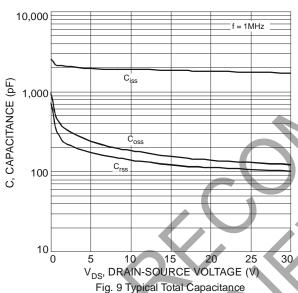
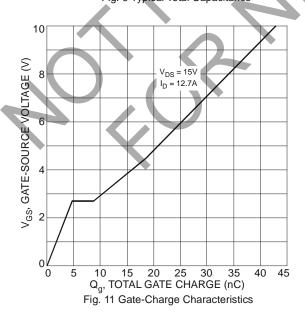
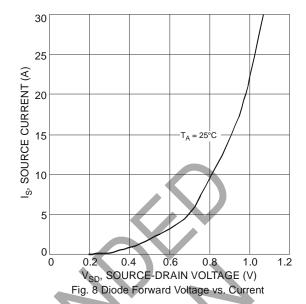
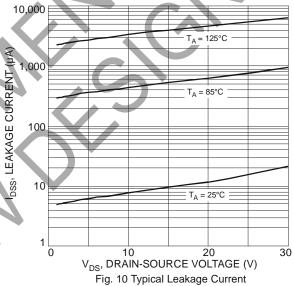


Fig. 7 Gate Threshold Variation vs. Ambient Temperature



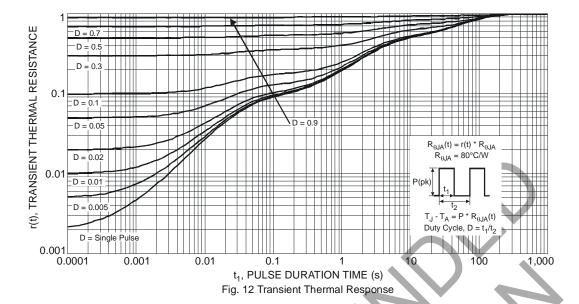






vs. Drain-Source Voltage

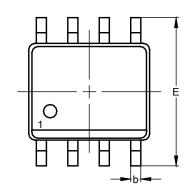


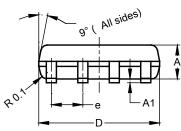


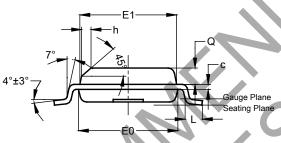


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version





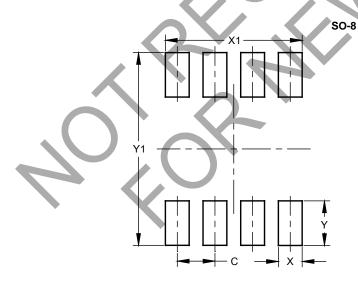


SO-8

SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е	_	_	1.27		
h	Ì	_	0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
X	0.802
X1	4.612
Y	1.505
Y1	6.50



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